VS-GT80DA120U



Vishay Semiconductors

Insulated Gate Bipolar Transistor (Trench IGBT), 80 A



PRIMARY CHARACTERISTICS							
V _{CES}	1200 V						
I _C DC	80 A at 104 °C						
V _{CE(on)} typical at 80 A, 25 °C	2.0 V						
Speed	8 kHz to 30 kHz						
Package	SOT-227						
Circuit configuration	Single switch with AP diode						

FEATURES

- Trench IGBT technology
- Positive V_{CE(on)} temperature coefficient
- Square RBSOA
- 10 µs short circuit capability
- HEXFRED[®] low Q_{rr}, low switching energy
- T_J maximum = 150 °C
- Fully isolated package
- Very low internal inductance (≤ 5 nH typical)
- Industry standard outline
- UL approved file E78996
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

BENEFITS

- Designed for increased operating efficiency in power conversion: UPS, SMPS, welding, induction heating
- Easy to assemble and parallel
- Direct mounting to heatsink
- Plug-in compatible with other SOT-227 packages
- Low EMI, requires less snubbing

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS			
Collector to emitter voltage	V _{CES}		1200	V			
Continuous collector current		T _C = 25 °C	139				
Continuous collector current	I _C	T _C = 90 °C	93				
Pulsed collector current	I _{CM}		170				
Clamped inductive load current	I _{LM}		250	А			
		T _C = 25 °C	98				
Diode continuous forward current	lF	T _C = 90 °C	61				
Single pulse forward current	I _{FSM}	10 ms sine or 6 ms rectangular pulse, T_J = 25 °C	350				
Gate to emitter voltage	V _{GE}		± 20	V			
	D.	T _C = 25 °C	658				
Power dissipation, IGBT	PD	T _C = 90 °C	316				
Power dissipation, diode	Р	T _C = 25 °C	403	W			
	P _D	T _C = 90 °C	194				
Isolation voltage	VISOL	Any terminal to case, t = 1 min	2500	V			



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ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS			
Collector to emitter breakdown voltage	V _{BR(CES)}	$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 2.6 \text{ mA}$	1200	-	-				
		$V_{GE} = 15 \text{ V}, I_{C} = 80 \text{ A}$	-	2.0	2.55				
Collector to emitter voltage	V _{CE(on)}	V_{GE} = 15 V, I_{C} = 80 A, T_{J} = 125 °C	-	2.4	-	V			
		V_{GE} = 15 V, I _C = 80 A, T _J = 150 °C	-	2.5	-				
Gate threshold voltage	V _{GE(th)}	$V_{GE(th)}$ $V_{CE} = V_{GE}$, $I_C = 2.6$ mA		5.7	7.0				
Temperature coefficient of threshold voltage	$\Delta V_{GE(th)}/\Delta T_J$	V_{CE} = V_{GE} , I_C = 2.6 mA (25 °C to 125 °C)	-	-12	-	mV/°C			
Collector to emitter leakage current	I _{CES}	V _{GE} = 0 V, V _{CE} = 1200 V	-	1.0	100	μA			
Collector to enlitter leakage current		$V_{GE} = 0 \text{ V}, \text{ V}_{CE} = 1200 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	0.9	-	mA			
		$I_F = 80 \text{ A}, V_{GE} = 0 \text{ V}$	-	2.9	3.5				
Forward voltage drop	V _{FM}	$I_F = 80 \text{ A}, V_{GE} = 0 \text{ V}, T_J = 125 ^\circ\text{C}$	-	3.1	-	V			
		$I_F = 80 \text{ A}, V_{GE} = 0 \text{ V}, T_J = 150 ^\circ\text{C}$	-	3.1	-				
Gate to emitter leakage current	I _{GES}	$V_{GE} = \pm 20 \text{ V}$	-	-	± 220	nA			

SWITCHING CHARACTE	RISTICS	$(T_J = 25 \ ^{\circ}C \text{ unless otherwise s})$	pecified)				
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Total gate charge (turn-on)	Qg	$V_{GE} = -15 \text{ V}, \text{ V}_{GE} = \pm 15 \text{ V}$	-	570	-		
Input capacitance	Cies			-	4400	-	~F
Reverse transfer capacitance	C _{res}	V _{CE} = 25 V, V _{GE} = 0 V, f = 1 MHz		-	235	-	pF
Turn-on switching loss	Eon	$I_{C} = 80 \text{ A}, V_{CC} = 600 \text{ V}, V_{GE} = 15 \text{ V},$		-	3.0	-	
Turn-off switching loss	E _{off}	$R_g = 1.0 \Omega, L = 500 \mu H,$		-	3.2	-	mJ
Total switching loss	E _{tot}	T _J = 25 °C		-	6.2	-	
Turn-on switching loss	Eon		Energy losses	-	3.9	-	
Turn-off switching loss	E _{off}		include tail and diode recovery Diode used HFA16PB120	-	5.5	-	mJ
Total switching loss	E _{tot}			-	9.4	-	
Turn-on delay time	t _{d(on)}	I_{C} = 80 A, V _{CC} = 600 V, V _{GE} = 15 V, R _q = 1.0 Ω, L = 500 µH, T _J = 125 °C		-	134	-	
Rise time	t _r	ig = 1.0 Ω, ε = 000 μii, ij = 120 °C		-	65	-	ns
Turn-off delay time	t _{d(off)}			-	281	-	115
Fall time	t _f			-	155	-	1
Reverse bias safe operating area	RBSOA		$\begin{array}{l} T_{J} = 150 \ ^{\circ}\text{C}, \ I_{C} = 250 \ \text{A}, \ R_{g} = 1.0 \ \Omega, \ V_{GE} = 15 \ \text{V to } 0 \ \text{V}, \\ V_{CC} = 800 \ \text{V}, \ V_{P} = 1200 \ \text{V}, \ L = 500 \ \mu\text{H} \end{array}$				
Diode reverse recovery time	t _{rr}			-	179	-	ns
Diode peak reverse current	l _{rr}	$I_F = 50 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}, V_R = 40$	I _F = 50 A, dI _F /dt = 200 A/μs, V _R = 400 V				Α
Diode recovery charge	Q _{rr}		-	1029	-	nC	
Diode reverse recovery time	t _{rr}		-	275	-	ns	
Diode peak reverse current	l _{rr}	I _F = 50 A, dI _F /dt = 200 A/µs, V _{rr} = 400 V, T _{.1} = 125 °C	I _F = 50 A, dI _F /dt = 200 A/μs,				Α
Diode recovery charge	Q _{rr}	$r_{\rm ff} = 100$ $r_{\rm f}$ $r_{\rm f} = 120$ O	-	2451	-	nC	
Short circuit safe operating area	SCSOA	$V_{GE} = 15 \text{ V}, V_{CC} = 800 \text{ V}, V_{CE} \text{ max.} = 1$	$V_{GE} = 15 \text{ V}, \text{ V}_{CC} = 800 \text{ V}, \text{ V}_{CE} \text{ max.} = 1200 \text{ V}, \text{ T}_{J} = 150 \text{ °C}$ 10				

THERMAL AND MECHANICAL SPECIFICATIONS									
PARAMETER		SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Junction and storage temperature range		T _J , T _{Stg}		-40	-	150	°C		
Junction to case	IGBT	R _{thJC}		-	-	0.19			
	Diode	nthJC		-	-	0.31	°C/W		
Case to heatsink		R _{thCS}	Flat, greased surface	-	0.1	-			
Weight				-	30	-	g		
Mounting torque			Torque to terminal	-	-	1.1 (9.7)	Nm (lbf. in)		
			Torque to heatsink	-	-	1.3 (11.5))	Nm (lbf. in)		
Case style		SOT-227							

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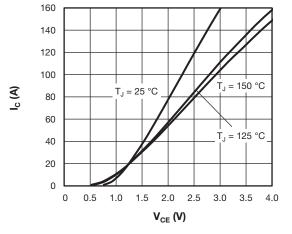


Fig. 1 - Typical IGBT Output Characteristics, V_{GE} = 15 V

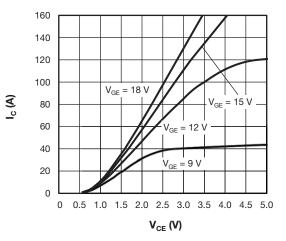


Fig. 2 - Typical IGBT Output Characteristics, T_J = 125 °C

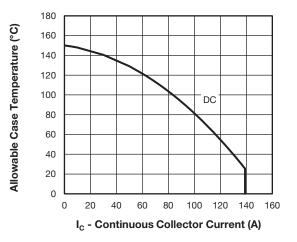


Fig. 3 - Maximum IGBT Continuous Collector Current vs. Case Temperature

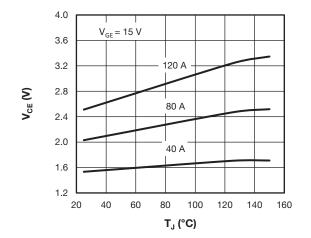


Fig. 4 - Collector to Emitter Voltage vs. Junction Temperature

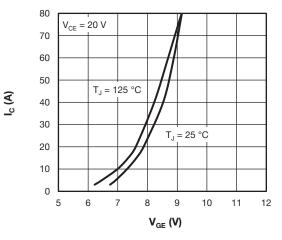


Fig. 5 - Typical IGBT Transfer Characteristics

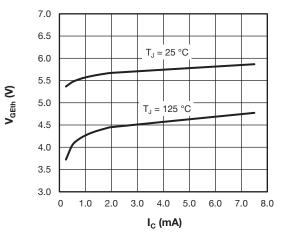


Fig. 6 - Typical IGBT Gate Threshold Voltage

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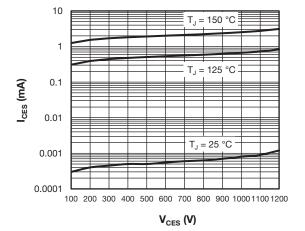


Fig. 7 - Typical IGBT Zero Gate Voltage Collector Current

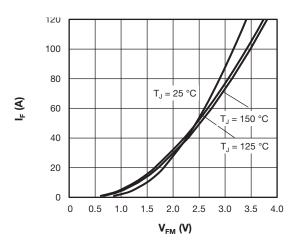


Fig. 8 - Typical Diode Forward Characteristics

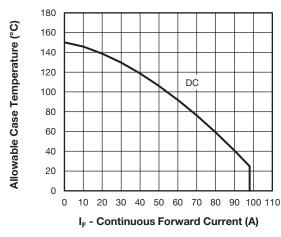


Fig. 9 - Maximum Diode Continuous Forward Current vs. Case Temperature

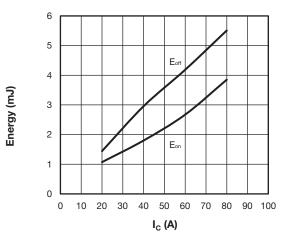


Fig. 10 - Typical IGBT Energy Loss vs I_C T_J = 125 °C, V_{CC} = 600 V, R_g = 1.0 $\Omega,$ V_{GE} = 15 V, L = 500 μH

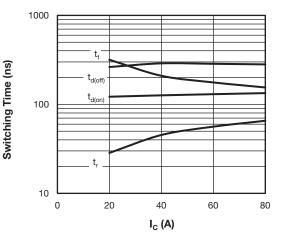


Fig. 11 - Typical IGBT Switching Time vs. I_C T_J = 125 °C, V_{CC} = 600 V, R_g = 1.0 $\Omega,$ V_{GE} = 15 V, L = 500 μH

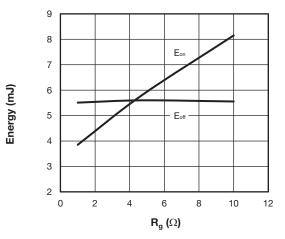


Fig. 12 - Typical IGBT Energy Loss vs. R_g T_J = 125 °C, V_{CC} = 600 V, I_C = 80 A, V_{GE} = 15 V, L = 500 μH

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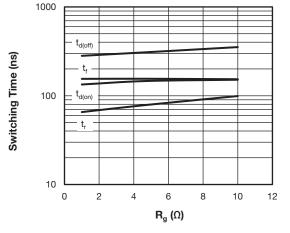


Fig. 13 - Typical IGBT Switching Time vs. R_g T_J = 125 °C, V_{CC} = 600 V, I_C = 80 A, V_{GE} = 15 V, L = 500 μH

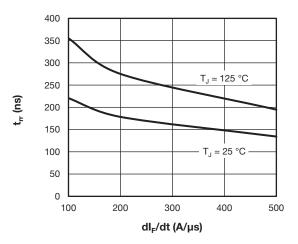


Fig. 14 - Typical Diode Reverse Recovery Time vs. dl_F/dt $V_{rr} = 400 \text{ V}, I_F = 50 \text{ A}$

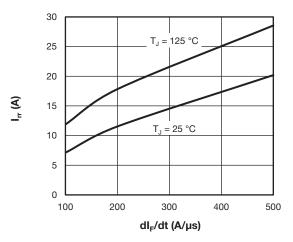


Fig. 15 - Typical Diode Reverse Recovery Current vs. dl_F/dt $V_{rr} = 400 \text{ V}, I_F = 50 \text{ A}$

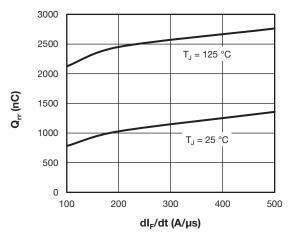


Fig. 16 - Typical Diode Reverse Recovery Charge vs. dl_F/dt $V_{rr} = 400 \text{ V}, I_F = 50 \text{ A}$

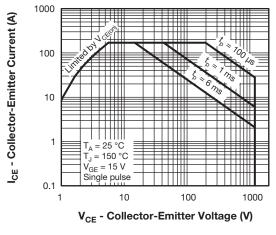
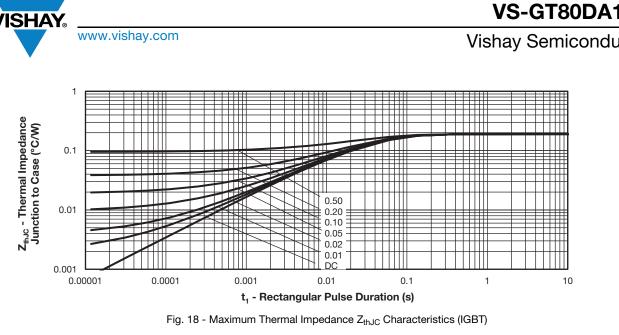
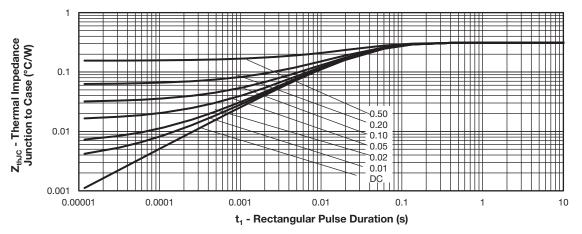
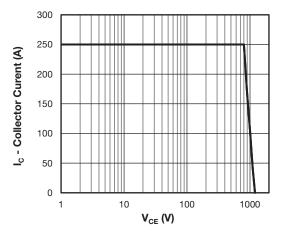


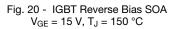
Fig. 17 - IGBT Safe Operating Area







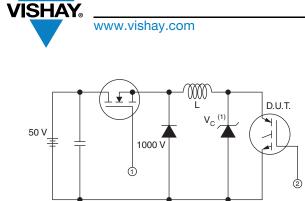




VS-GT80DA120U

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Note: ⁽¹⁾ Driver same type as D.U.T.; $V_C = 80$ % of V_{CE} max. Due to the 50 V power supply, pulse width, and inductor will increase to obtain ID

Fig. 21 - Clamped Inductive Load Test Circuit

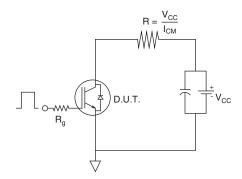


Fig. 22 - Pulsed Collector Current Test Circuit

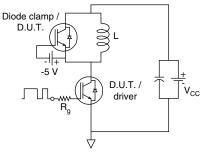


Fig. 23 - Switching Loss Test Circuit

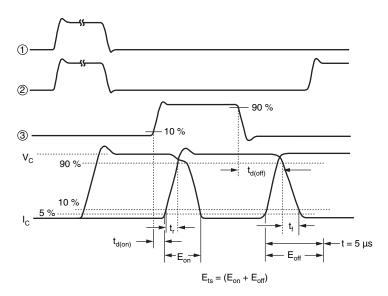


Fig. 24 - Switching Loss Waveforms Test Circuit



ORDERING INFORMATION TABLE

Device code	VS-	G	т	80	D	Α	120	U
		2	3	4	5	6	7	8
	1 -	Visl	nay Sen	niconduc	ctors pro	oduct		
	2 -	์ ไทรเ	ulated g	ate bipo	lar trans	sistor (IC	GBT)	
	3 -	Tre	nch IGB	T techn	ology			
	4 -	Cur	rent rati	ng (80 =	= 80 A)			
	5 -	Circ	cuit conf	iguratior	n (D = s	ingle sw	/itch wit	h antipa
	6 -	Pac	kage in	dicator (A = SO	T-227)		
	7 -	Vol	tage rati	ing (120	= 1200	V)		
	8 -	Spe	ed / typ	e (U = u	ltrafast)			

CIRCUIT CONFIGURATION								
CIRCUIT	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING						
Single switch with AP diode	D	2 (G) 1,4 (E) Lead Assignment Lead Assignment 1 Lead Assignm						

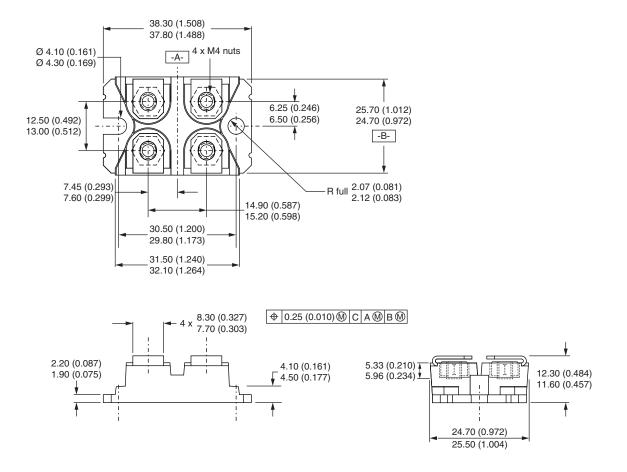
LINKS TO RELATED DOCUMENTS						
Dimensions www.vishay.com/doc?95423						
Packaging information	www.vishay.com/doc?95425					





SOT-227 Generation 2

DIMENSIONS in millimeters (inches)



Note

• Controlling dimension: millimeter



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25.163.0653.1 25	.163.2453.0	25.163.4253.0	25.190.2053.0	25.194.3453.0	25.320.4853.1	25.320.5253.1	25.326.3253.1	25.326.3553.1
25.330.1653.1 25.	.330.4753.1	25.330.5253.1	25.334.3253.1	25.334.3353.1	25.350.2053.0	25.352.4753.1	25.522.3253.0	<u>T483C</u> <u>T484C</u>
<u>T485F</u> <u>T485H</u> <u>T5</u>	512F-YEB 1	<u>T513F</u> <u>T514F</u>	T554 T612FSE	25.161.3453.0	25.179.2253.0	25.194.3253.0	25.325.1253.1	25.326.4253.1
25.330.0953.1 25.	.332.4353.1	25.350.1653.0	25.350.2453.0	25.352.1453.0	25.352.1653.0	25.352.2453.0	25.352.5453.1	25.522.3353.0
25.602.4053.0								